

LCD DevPack

rev. 1.0

Item Num	Part Reference	Quantity	Value	Description	MPN	Manufacturer
1	C1	1	100nF	CAPACITOR, CERAMIC X7R, 100nF, 25V, -10%/+10%, -55DEGC/+125DEGC, 0603, SMD	GRM188R71E104KA01D	MURATA
2	C2 C3	2	1uF	CAPACITOR, CERAMIC X5R, 1uF, 25V, -10%/+10%, -55DEGC/+85DEGC, 0603, SMD	GRM188R61E105KA12D	MURATA
3	CR1	1	LS013B4DN04	OPTO, DISPLAY, LCD, 2.7V TO 3.3V, NOT APPLY	LS013B4DN04	SHARP
4	FIDU1 FIDU2 FIDU3 FIDU4 FIDU5 FIDU6	DNM	FIDU_1.27mm	FIDUCIAL MARK, ROUND 1.27MM		
5	J2	1	LSS-110-01-F-DV-A-TR	CONNECTOR, HEADER, HI-SPEED SOCKET, FEMALE, STRAIGHT, 2 ROWS,20 PINS, PITCH 0.635mm, SMD	LSS-110-01-F-DV-A-TR	SAMTEC
6	J3	1	AYF531035	CONNECTOR, FLEXI, FEMALE, RIGHT ANGLE, TOP AND BOTTOM DOUBLE CONTACTS, 1ROW, 10PINS, PITCH 0.5mm, SMD	AYF531035	PANASONIC INDUSTRIAL
7	R1	1	820k	RESISTOR, THICK FILM, 820k, -1%/+1%, 0.1W, 75V, -55DEGC/+155DEGC, 0603, SMD	CRCW0603820KFKEA	VISHAY

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